

Research and Development of Novel Advanced Materials for Nextgeneration Collimators

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What is a (Phase I) LHC collimator



SC magnets and particle physics exp.



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What is a (Phase I) LHC Collimator

Robustness Test at 450 GeV, 3.2x10¹³ protons per shot

- Incention System Incent • 5 full intensity shots ranging
- Each impact energy equivalent

carbon jaw

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mir

Graphite jaw



Limits of Phase I Collimators





Figures of Merit

Five **Figures of Merit** have been identified to classify and rank candidate materials

- Electrical Conductivity
- Ate indicators are somehow self-conflicting. These indicators are somehow self-conflicting.
 - Can we try and combine properties of diverse

Z

... andard" requirements include ...

anon Hardness, UHV Compatibility, Industrial producibility of large components (up to 400x80x25 mm³), Possibility to machine, braze, join, coat ..., Limited brittleness

 T_m

Metal-diamond Composites

- Metal-diamond composites are advanced thermal management materials combining properties of Diamond (high *k*, low *ρ* and low *CTE*) with those of Metals (strength, *γ*, etc.).
- Sintering techniques include **Rapid Hot Pressing (RHP)**, aka Spark Plasma Sintering **(SPS)**, and **Liquid Infiltration**.
- Candidate materials include Copper-diamond (Cu-CD), Silver-diamond (Ag-CD) and Molybdenum-diamond (Mo-CD)





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Material	C-C	Мо	Glidcop ®	Cu-CD	Ag-CD	Mo-CD
Density [kg/m ³]	1650	10220	8900	~5400	~6100	~6900
Atomic Number (Z)	6	42	29	~11.4	~22.4	~17.3
T _m [°C]	3650	2623	1083	~1083	~840	~2623
SSNI [kWm²/kg]	24	2.6	2.5	13.1 ÷ 15.3	11.4 ÷ 15.4	6.9 ÷ 10.9
TSNI [kJ/kg]	793	55	35	44 ÷ 51	60 ÷92	72 ÷ 96
Electrical Conductivity [MS/m]	0.14	19.2	53.8	~12.6	~11.8	~9.9
	worse				better	

- **C-C** stands out as to thermo-mechanical performances. Adversely outweighed by poor electrical conductivity, low Z, expected degradation under irradiation.
- **High-Z metals** (**Cu**, **Mo**) possess very good electrical properties. High density adversely affects their thermal stability and accident robustness.
- **Metal-diamond composites** exhibit a balanced compromise between TSNI, SSNI, electrical conductivity , density, atomic number.
- Mo-CD limits the consequences of high temperatures induced by very intense beam impacts

Cu-CD Composites

• Cu-CD developed by RHP-Technology (spin-off of Austrian Institute of Technology), Austria

EUCARD

- Characterized in the frame of EuCARD / ColMat collaboration
- R&D objectives:

FRN

• Geometrical stability

- Electrical conductivity
- Intermediate density
- Produced by RHP under N₂ + H₂ Atmosphere
- 60% Diamond, 40% Cu
- Small addition of Boron
- Sintering T $\sim 1000^{\circ}$ C
- Good homogeneity and compaction rate (~95%)





Courtesy: **E. Neubauer, M. Kitzmantel** – RHP-Tech





Cu-CD Composites

 No diamond degradation (in reducing atmosphere graphitisation starts at ~ 1300 °C)

EUCARD

Good thermal (~490 W/mK) and electrical conductivity (~12.6 MS/m).

No direct interface between Cu and CD (lack of affinity). Limited bonding surface assured by Boron Carbides hampers mechanical strength (~120 MPa).

BC brittleness adversely affects material toughness.

Cu low melting point (**1083** °**C**) limits Cu-CD applications for highly energetic accidents.

CTE increases significantly with T due to high Cu content (from ~6 ppmK⁻¹ at RT up to ~12 ppmK⁻¹ at 900 °C)







Ag-CD Composites

- Developed by **EPFL**, Switzerland.
- Characterized at EPFL and CERN (EuCARD).
- Manufactured by Liquid Infiltration of cylindrical samples (Ø100 mm, H 100 mm)
- ~60% Diamond, ~40% Ag-Si alloy
- Excellent bonding between Ag and CD assured by Silicon Carbides formation on diamond.
 - High Flexural Strength (~500 MPa) and toughness.
- High Electrical Conductivity.
- Max T_{Service} limited by low-melting eutectic phase Ag-Si (**840** °**C**).
- Hard to manufacture large components (>100 mm)
- Material non homogeneities due to liquid metal infiltration intrinsic limitations.







- Co-developed by **CERN** and a SME, **Brevetti Bizz**, Verona, Italy •
- R&D objectives :
 - **Decrease** pure Mo **density** to optimize deposited energy distribution
 - Increase mechanical properties w.r.t. other Metal-CD
 - Increase thermal stability and robustness at high temperatures
- Manufactured through RHP
- Mo and CD create a good interface by forming Mo Carbides.
- Large components can be produced.

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- High sintering T of Mo (~1700 °C) leads to diamond graphitisation. 2 alternative processes:
 - Assisted Solid-state Sintering (ASS)
 - Liquid Phase Sintering (LPS)









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Mo-CD Composites

Liquid Phase Sintering (LPS)

Addition of low-melting phase (Cu or Cu-Ag) to fill in the pores between Mo and CD

- Good mechanical strength (400+ MPa) and Thermal Conductivity (185 W/mK)
- Max T_{Service} limited by low-melting phase (Cu)



Assisted Solid-state Sintering (ASS)

- Addition of small amounts of activating elements (Ni, Pd) enhances Mo sintering at low T (~1300 °C)
- Absence of low-melting phase increases service T up to $\sim 2600 \,^{\circ}\text{C}$
- Large diamond particles interfere with Mo compaction.
- Diamond graphitization not fully avoided.

 Mo-Pd Matrix

 Reaction layer:

 Molybdenum Carbides

 Synthetic Diamond

 Bynthetic Diamond

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Studied material comparison

- A single, comprehensive comparison of characterized materials is proposed on the basis of normalized Figures of Merit.
- Needless to say, any choice of Figures of Merit, of their combination and target values is arbitrary ...
- This said, this comparison confirms that Mo-CD is, so far, the best candidate.





Simulations and Testing

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EUCARD

• Irradiation damage tests at RRC-KI and GSI.

- Preliminary results from GSI on Cu-CD show no degradation of Cu/CD interface. Defects in CD lattice seem to occur.
- Advanced simulations being performed at CERN and Polito on materials under extreme conditions.
- Beam tests in CERN's **HiRadMat** to experimentally assess material models.



Courtesy: M. Tomut -

GSI





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Conclusions

- Bringing LHC beyond nominal performances might require new generation collimators embarking novel advanced materials.
- Metal-diamond composites are particularly appealing as they promise to combine diamond and metal properties.
- Figures of Merit were defined, allowing to pinpoint "best" candidates and to set ambitious goals.
- An intense R&D program has been launched at CERN with partners partly within the EuCARD collaboration
- Cu-CD, Mo-CD and Ag-CD were studied and successfully produced. Size challenge has been met for Cu-CD and Mo-CD.
- A large characterization effort has been carried out: a magic material does not exist, but Mo-CD seems to stand out as a balanced compromise between key parameters.
- Radiation hardness assessment is ongoing for selected materials. Beam tests under extreme conditions are foreseen at CERN's HiRadMat facility.
- The R&D program is still in full progress.





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